

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MONIKA CHHORNG	11/11/2019
DAVID J. LEE	11/11/2019
RAHUL KAMATH	11/11/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ENEVATE CORPORATION
<b>Street Address:</b>	101 THEORY
<b>City:</b>	IRVINE
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92617
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17712840
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<b>ATTORNEY DOCKET NUMBER:</b>	63897US03
<b>NAME OF SUBMITTER:</b>	JEFFREY B. HUTER
<b>SIGNATURE:</b>	/Jeffrey B. Huter/
<b>DATE SIGNED:</b>	04/04/2022
<b>Total Attachments: 1</b>	
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**ASSIGNMENT**

Whereas, I, **MONIKA CHHORNG, DAVID J. LEE, and RAHUL KAMATH**, having agreed to assign the below identified invention to **ENEVATE CORPORATION ("ENEVATE")**, a corporation having its principal place of business at **101 Theory, Irvine, CA 92617** for good and valuable consideration, receipt of which is hereby acknowledged, I do hereby sell, assign, and transfer unto **ENEVATE**, its successors and assigns, the entire right, title, and interest, including the right of priority and action for past infringements in, to and under an application for Letters Patents of the United States entitled:

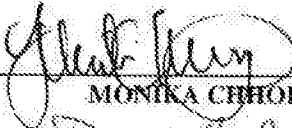
**LOWER PYROLYSIS TEMPERATURE BINDER FOR SILICON-DOMINANT ANODES**

  X   filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor, including any priority applications, continuations, divisionals, reissues, reexaminations, extension, and foreign counterparts of such application and of such Letters Patent; or

Serial No.: \_\_\_\_\_, filed on \_\_\_\_\_ and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore, including any priority applications, continuations, divisionals, reissues, reexaminations, extension, and foreign counterparts of such application and of such Letters Patent;

And for the above consideration, I agree promptly upon request of **ENEVATE**, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional, or reissue, or other papers which may be necessary or desirable fully to secure to **ENEVATE**, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent.

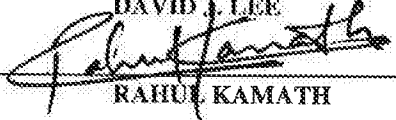
Inventor's Signature: \_\_\_\_\_

  
**MONIKA CHHORNG**Date: 11/11/19

Inventor's Signature: \_\_\_\_\_

  
**DAVID J. LEE**Date: 11/11/19

Inventor's Signature: \_\_\_\_\_

  
**RAHUL KAMATH**Date: 11/11/19**PATENT**